



## **Supplemental Application Data Sheet**

### **Application Information**

<u>Application Serial No.::</u>	<u>10/512,405</u>
Application Type::	Regular
Subject Matter::	Utility
Suggested Group Art Unit::	N/A
CD-ROM or CD-R?::	None
Sequence submission?::	None
Computer Readable Form (CRF)?::	No
Title::	HIGH-RESISTANCE SILICON WAFER AND ITS MANUFACTURING METHOD
Attorney Docket Number::	<b>474082002800</b>
Request for Early Publication?::	No
Request for Non-Publication?::	No
Total Drawing Sheets::	6
Small Entity?::	No
Petition included?::	No
Secrecy Order in Parent Appl.?::	No

### **Applicant Information**

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### **Correspondence Information**

Correspondence Customer Number:: 25227

### **Representative Information**

Representative Customer Number:: 25227

### Continuity Information

This application is a:: 35 USC 371  
Application No.:: PCT/JP03/04866  
Filing Date:: April 16, 2003

### Foreign Priority Information

Country::	Application number::	Filing Date::	Priority Claimed::
Japan	2002-127509	April 26, 2002	Yes
Japan	2002-360731	December 12, 2002	Yes

### Assignee Information

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